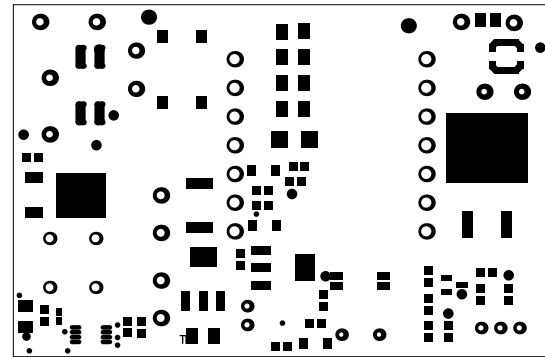
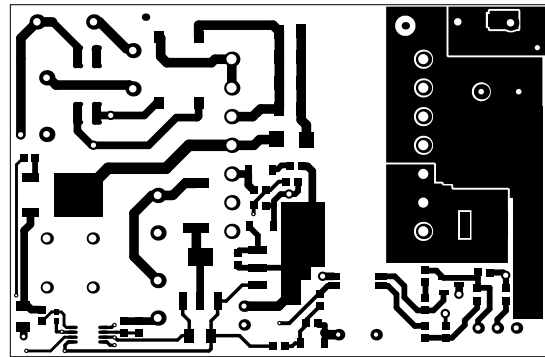


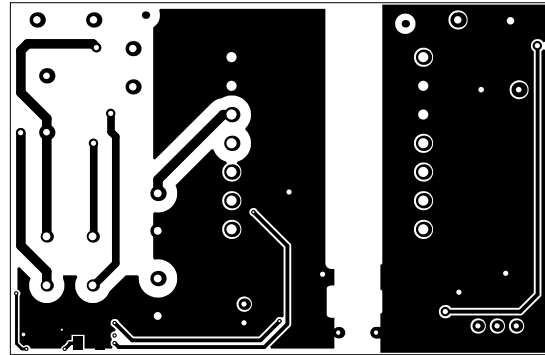
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7883 REVC	
LAYER NAME = Top Overlay	ARTWORK # = 880_prj_BasePN - PCB_C882924Rev	TEXAS INSTRUMENTS
PLOT NAME = Top Overlay	GENERATED : 3/4/2013	4:59:24 PM



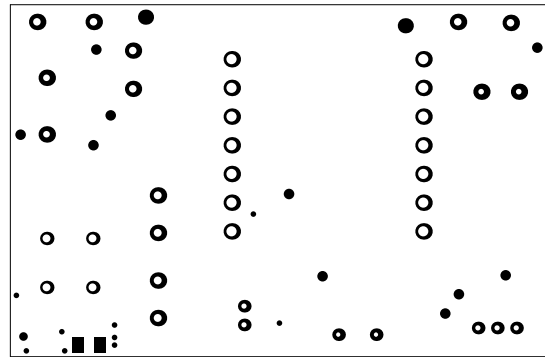
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME =	PMP7883 REVC		
LAYER NAME =	Top Solder	ARTWORK # =	880_prj_BasePN - PCB_C88024Rev	TEXAS INSTRUMENTS
PLOT NAME =	Top Solder Mask	GENERATED :	3/4/2013	4:59:24 PM



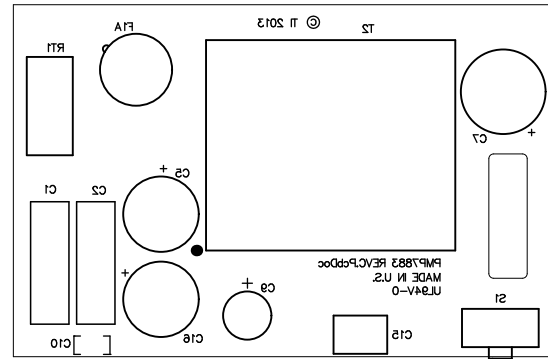
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME =	PMP7883 REV C		
LAYER NAME =	Top Layer	ARTWORK # =	880_prj_BasePN - PCB_C880_04Rev	TEXAS INSTRUMENTS
PLOT NAME =	Top Layer	GENERATED :	3/4/2013	4:59:25 PM



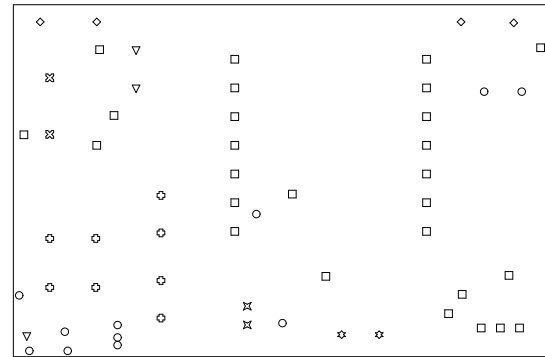
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME =	PMP7883 REV C		
LAYER NAME =	Bottom Layer	ARTWORK # =	880 .prj_BasePN - .PCB_C88024Rev	TEXAS INSTRUMENTS
PLOT NAME =	Bottom Layer	GENERATED :	3/4/2013	4:59:25 PM



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME =	PMP7883 REVC		
LAYER NAME =	Bottom Solder	ARTWORK # =	880 .prj_BasePN - .PCB_C88024Rev	TEXAS INSTRUMENTS
PLOT NAME =	Bottom Solder Mask	GENERATED :	3/4/2013	4:59:26 PM



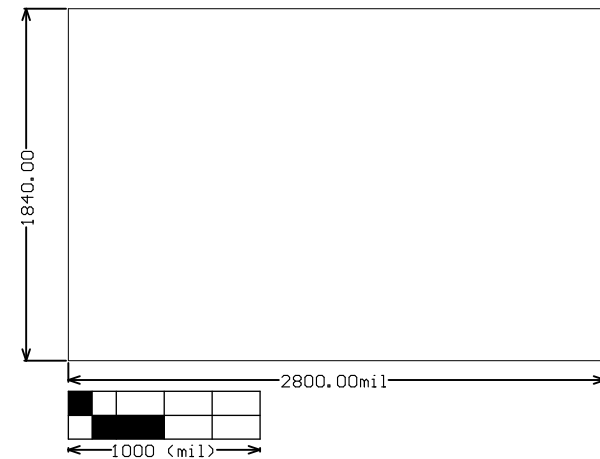
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME =	PMP7883 REV.C	
LAYER NAME =	Bottom Overlay	ARTWORK # =	880 .prj_BasePN - PCB_C88024Rev TEXAS INSTRUMENTS
PLOT NAME =	Bottom Overlay	GENERATED :	3/4/2013 4:59:26 PM



Symbol	Hit Count	Tool Size	Plated	Hole Type
◇	9	12mil (0.305mm)	PTH	Round
▽	1	20mil (0.508mm)	PTH	Round
✱	2	23.622mil (0.6mm)	PTH	Round
⊠	2	27.559mil (0.7mm)	PTH	Round
□	13	28mil (0.711mm)	PTH	Round
○	2	30mil (0.762mm)	PTH	Round
⊗	2	35mil (0.889mm)	PTH	Round
▽	2	39.37mil (1mm)	PTH	Round
◇	4	40mil (1.016mm)	PTH	Round
○	8	42mil (1.067mm)	PTH	Round
□	14	55mil (1.397mm)	PTH	Round
	59	Total		

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME =	PMP7883 REVC	
LAYER NAME =	Drill Drawing	ARTWORK # =	880_prj_BasePN - PCB_C880_024Rev
PLOT NAME =	Drill Drawing	GENERATED :	3/4/2013 4:59:27 PM
		TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME =	PMP7883 REVC	
LAYER NAME =	M2 Board Dimensions	ARTWORK # =	880 .prj_BasePN - .PCB_C88024Rev
PLOT NAME =	Board Dimensions	GENERATED :	3/4/2013 4:59:27 PM
		TEXAS INSTRUMENTS	

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